

L Number	Hits	Search Text	DB	Time stamp
1	783	{430/312}.CCLS.	USPAT	2004/03/13 19:18
2	11	("6153978" "6137213" "6137272" "6096570" "6008576" "5877594" "5557596" "5541473" "5528103" "5090932" "4923421").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/13 19:24
3	0	((("6153978" "6137213" "6137272" "6096570" "6008576" "5877594" "5557596" "5541473" "5528103" "5090932" "4923421").PN.) and (undercut\$5 under adj cut\$5)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/13 19:25
4	8	((("6153978" "6137213" "6137272" "6096570" "6008576" "5877594" "5557596" "5541473" "5528103" "5090932" "4923421").PN.) and (radius diameter)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/13 19:25
5	25	(field adj emission fed).ab,ti,clm. and overhang with gate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/13 19:51
6	1	(field adj emission fed).ab,ti,clm. and overhang\$4 with (micron mil ".mu.m" micrometer micrometre micro adj (meter metre) nanometer nm \$6".angstrom.") same gate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/13 20:07
7	1	5232549.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/13 20:07
-	2	20020190623.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 11:09
-	1	20020190623.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 12:22
-	2	5413513.pn. 5658832.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 11:23
-	1	20020190623.did. and (ratio etching microns)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 13:19
-	4198	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.	USPAT	2004/03/12 13:46
-	523	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.	US-PGPUB	2004/03/12 13:40
-	5706	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:48
-	38	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:06
-	5706	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:48
-	38	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:48

-	38	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer) and etch\$6 with (undercut under adj cut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:58
-	5	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer) and etch\$6 with (undercut under adj cut) and (tunnel\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:58
-	15	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) same (micron ratio ".mu.m" micrometer micrometre nanometer nanometre)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:16
-	2	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) same (micron ratio ".mu.m" micrometer micrometre nanometer nanometre) and tunnel\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:50
-	1	20020190623.did. and tunneling adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:23
-	0	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 adj profile with (undercut under adj cut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:51
-	2529	(313/495-497,310).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 15:30
-	66	((313/495-497,310).CCLS.) and (undercut under adj cut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 17:40
-	12	((313/495-497,310).CCLS.) and (ledge) not (((313/495-497,310).CCLS.) and (undercut under adj cut))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 16:12
-	2037	(430/313,316,317.318).CCLS.	USPAT; US-PGPUB	2004/03/12 16:12
-	194	((430/313,316,317.318).CCLS.) and (undercut ledge under adj cut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 16:14
-	229	((430/313,316,317.318).CCLS.) and (undercut\$5 ledge under adj cut\$6) same etch\$8	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 16:18
-	63	((430/313,316,317.318).CCLS.) and (undercut\$5 ledge under adj cut\$6) same etch\$8 same (micron ".mu.m" "mu.m" "mu.m." micrometer micro adj (meter metre) micrometre nanometer nm "angstrom")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 17:24
-	1	20020190623.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 17:25
-	1	20020190623.did. and undercut	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 17:25

-	11	((313/495-497,310).CCLS.) and (undercut\$4 under adj cut\$5) not (((313/495-497,310).CCLS.) and (undercut under adj cut)) not (((313/495-497,310).CCLS.) and (ledge) not (((313/495-497,310).CCLS.) and (undercut under adj cut)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 18:50
-	8	(field adj emission fed).ab,ti,clm. and undercut\$5 with aspect adj ratio	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/13 19:42

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3	0	((("6153978" "6137213" "6137272" "6096570" "6008576" "5877594" "5557596" "5541473" "5528103" "5090932" "4923421").PN.) and (undercut\$5 under adj cut\$5)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/13 19:25
4	8	((("6153978" "6137213" "6137272" "6096570" "6008576" "5877594" "5557596" "5541473" "5528103" "5090932" "4923421").PN.) and (radius diameter)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/13 19:25
5	25	(field adj emission fed).ab,ti,clm. and overhang with gate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/13 19:51
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-	5706	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:48
-	38	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:06
-	5706	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:48
-	38	((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:48

-	38	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer) and etch\$6 with (undercut under adj cut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:58
-	5	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) and polymer) and etch\$6 with (undercut under adj cut) and (tunnel\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 13:58
-	15	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) same (micron ratio ".mu.m" micrometer micrometre nanometer nanometre)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:16
-	2	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 with (undercut under adj cut) same (micron ratio ".mu.m" micrometer micrometre nanometer nanometre) and tunnel\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:50
-	1	20020190623.did. and tunneling adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:23
-	0	((((445/24,25) or (427/77,105,106,133) or (437/228) or (430/325)).CCLS.) and etch\$6 adj profile with (undercut under adj cut)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 14:51
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-	1	20020190623.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 17:25
-	1	20020190623.did. and undercut	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/03/12 17:25

-	11	((313/495-497,310).CCLS.) and (undercut\$4 under adj cut\$5) not (((313/495-497,310).CCLS.) and (undercut under adj cut)) not (((313/495-497,310).CCLS.) and (ledge) not (((313/495-497,310).CCLS.) and (undercut under adj cut)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/12 18:50
-	8	(field adj emission fed).ab,ti,clm. and undercut\$5 with aspect adj ratio	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/13 19:42